Field Stop Trench IGBT 40 A, 650 V

AFGHL40T65SPD

Description

Using the novel field stop 3rd generation IGBT technology, AFGHL40T65SPD offers the optimum performance with both low conduction loss and switching loss for a high efficiency operation in various applications, which provides 50 V higher blocking voltage and rugged high current switching reliability.

Meanwhile, this part also offers and advantage of outstanding performance in parallel operation.

Features

- AEC-Q101 Qualified
- Low Saturation Voltage: $V_{CE(Sat)} = 1.85 \text{ V} (Typ.) @ I_C = 40 \text{ A}$
- 100% Of The Part Are Dynamically Tested (Note 1)
- Short Circuit Ruggedness > 5 µS @ 25°C
- Maximum Junction Temperature: T_J = 175°C
- Fast Switching
- Tight Parameter Distribution
- Positive Temperature Co-efficient for Easy Parallel Operating
- Co-Packed With Soft And Fast Recovery Diode

Typical Applications

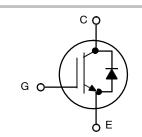
- On-board Charger
- Air Conditioner Compressor
- PTC Heater
- Motor Drivers
- Other Automotive Power-Train Applications



ON Semiconductor®

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V _{CES}	Eon	V _{CE(Sat)}
650 V	1.16 mJ	1.85 V





MARKING DIAGRAM



\$Y	= ON Semiconductor Logo
&Z	= Assembly Plant Code
&3	= 3-Digit Data code
&K	= 2-Digit Lot Traceability code
AFGHL40T65SPD	= Specific Device Code

ORDERING INFORMATION

Device	Package	Shipping
AFGHL40T65SPD	TO-247-3L	30 Units / Rail

Symbol	ymbol Description		Units	
V _{CES}	Collector to Emitter Voltage	650	V	
V _{GES}	Gate to Emitter Voltage	±20	V	
	Transient Gate to Emitter Voltage	±30	V	
Ι _C	Collector Current @ $T_C = 25^{\circ}C$	80	Α	
	Collector Current @ T _C = 100°C	40		
I _{CM}	Pulsed Collector Current (Note 2)	120	А	
١ _F	Diode Forward Current @ T _C = 25°C	40	А	
	Diode Forward Current @ T _C = 100°C	20		
I _{FM}	Pulsed Diode Maximum Forward Current (Note 2)	120	А	
PD	Maximum Power Dissipation @ $T_C = 25^{\circ}C$	267	W	
	Maximum Power Dissipation @ T _C = 100°C	134		
SCWT	Short Circuit Withstand Time @ $T_C = 25^{\circ}C$	5	μs	
TJ	Operating Junction Temperature	–55 to +175	°C	
T _{stg}	Storage Temperature Range	–55 to +175	°C	
ΤL	Maximum Lead Temp. For soldering Purposes, 1/8" from case for 5 seconds	300	°C	

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, Unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.
1. V_{CC} = 400 V, V_{GE} = 15 V, I_C = 120 A, R_G = 20 Ω, Inductive Load.
2. Repetitive rating: pulse width limited by max. Junction temperature.

THERMAL CHARACTERISTICS

Symbol	Rating	Max.	Units
$R_{\theta JC}$	Thermal Resistance Junction to Case, for IGBT	0.43	°C/W
R _{0JC}	Thermal Resistance Junction to Case, for Diode	1.69	°C/W
$R_{\theta JA}$	Thermal Resistance Junction to Ambient	40	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Parameter	Test Conditions	Symbol	Min.	Тур.	Max.	Unit
OFF CHARACTERISTICS						
Collector-emitter Breakdown Voltage, Gate-emitter Short-circuited	V _{GE} = 0 V, I _C = 1mA	BVCES	650	-	-	V
Temperature Coefficient of Breakdown Voltage	V _{GE} = 0 V, I _C = 1mA		-	0.6	-	V/°C
Collector-emitter Cut-off Current, Gate-emitter Short-circuited	V _{GE} = 0 V, V _{CE} = 650 V V _{GE} = 0 V, V _{CE} = 650 V, T _{J =} 175°C	ICES		_ 750	250 -	μΑ
Gate Leakage Current, Collector-emitter Short-circuited	$V_{GE} = 20 \text{ V}, \text{ V}_{CE} = 0 \text{ V}$	IGES	-	-	±400	nA
ON CHARACTERISTICS					1	1
Gate-emitter Threshold Voltage	$V_{GE} = V_{CE}$, $I_C = 40 \text{ mA}$	VGE(th)	4.0	5.0	7.5	V
Collector-emitter Saturation Voltage	V _{GE} = 15 V, I _C = 40 A V _{GE} = 15 V, I _C = 40 A, T _J = 175°C	VCE(sat)	1.4 _	1.85 2.51	2.4	V
DYNAMIC CHARACTERISTICS				I		
Input Capacitance	V _{CE} = 30 V, V _{GE} = 0 V, f = 1 MHz	Cies	-	1518	-	pF
Output Capacitance		Coes	-	91	_	
Reverse Transfer Capacitance		Cres	-	15	_	
Gate Charge Total	V _{CE} = 400 V, I _C = 40 V, V _{GE} = 15 V	Q _q	-	36	_	nC
Gate to Emitter Charge		Qge	-	11	_	
Gate to Collector Charge	-	Qgc	_	12	_	
SWITCHING CHARACTERISTICS		0				
Turn-on Delay Time	$T_{\rm C} = 25^{\circ}{\rm C}$	td(on)	-	18	_	ns
Rise Time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 40 \text{ A}$ Rg = 6 Ω	t _r	_	42	_	
Turn-off Delay Time		td(off)	_	35	_	
Fall Time		t _f	_	10	_	
Turn-on Switching Loss	-	Eon	_	1.16	_	mJ
Turn-off Switching Loss	-	Eoff	_	0.27	_	
Total Switching Loss	-	Ets	_	1.43	_	
Turn-on Delay Time	T _C = 175°C	td(on)	_	16	_	ns
Rise Time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 40 \text{ A}$ Rg = 6 Ω	t _r	_	40	_	
Turn-off Delay Time	V _{GE} = 15 V	td(off)	_	37	_	
Fall Time	Inductive Load	t _f	_	11	_	
Turn-on Switching Loss	-	Eon	_	1.59	_	mJ
Turn-off Switching Loss	-	Eoff	_	0.42	_	
Total Switching Loss	-	Ets	_	2.01	_	
DIODE CHARACTERISTICS						
Forward Voltage	I _F = 20 A I _F = 20 A, T _J = 175°C	V _F	1.4 _	2.2 1.9	2.7	V
Reverse Recovery Time	$T_J = 25^{\circ}C$	trr	_	35	_	ns
Reverse Recovery Charge	I _F = 20 A, di _F /dt = 200 A/μs	Qrr	-	58	_	μC
Reverse Recovery Time	T _J = 175°C	trr	-	214	_	ns
Reverse Recovery Charge	I _F = 20 A, di _F /dt = 200 A/μs	Qrr	-	776	_	μC
Reverse Recovery Energy		Erec	_	51		μJ

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL PERFORMANCE CHARACTERISTICS

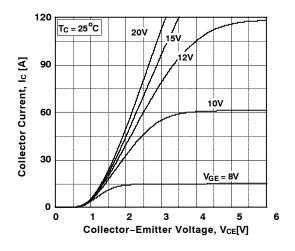
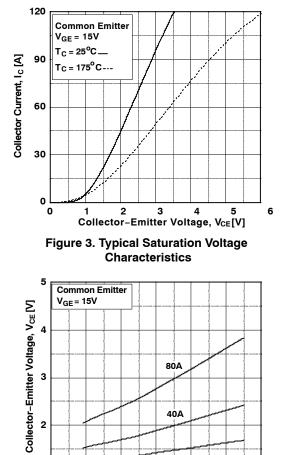


Figure 1. Typical Output Characteristics



1 -100 -50 0 50 100 150 200 Collector-Emitter Case Temperature, T_C[°C]



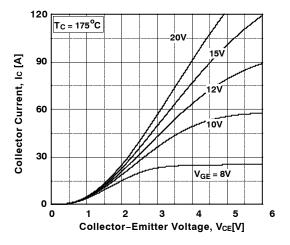
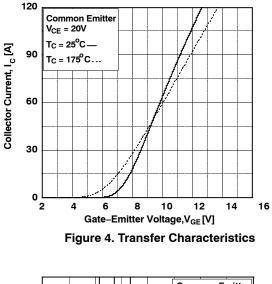
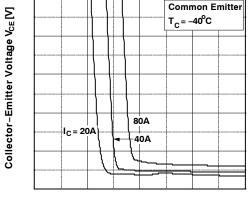


Figure 2. Typical Output Characteristics





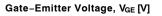


Figure 6. Saturation Voltage vs. V_{GE}

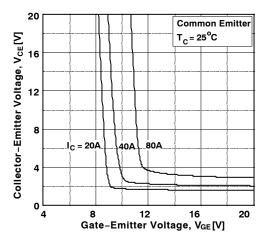


Figure 7. Saturation Voltage vs. V_{GE}

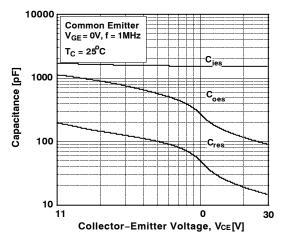
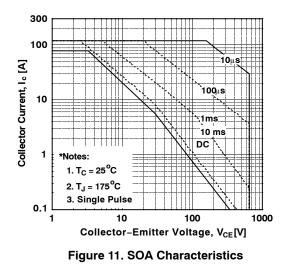
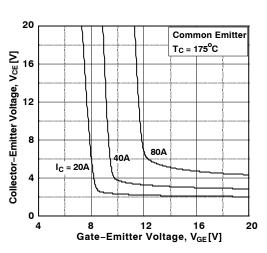


Figure 9. Capacitance Characteristics







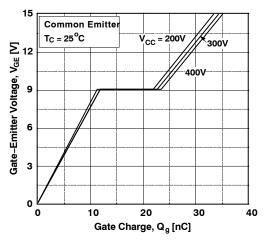
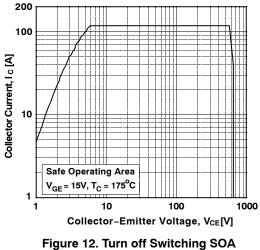


Figure 10. Gate charge Characteristics



Characteristics

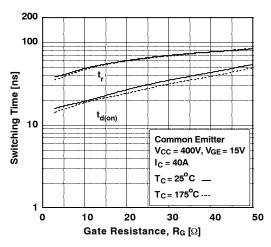


Figure 13. Turn-on Characteristics vs. Gate Resistance

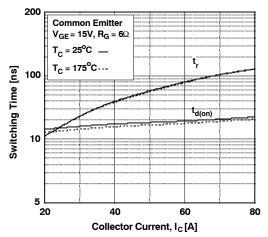
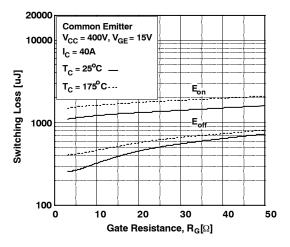


Figure 15. Turn-on Characteristics vs. Collector Current





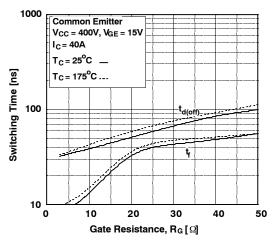


Figure 14. Turn-off Characteristics vs. Gate Resistance

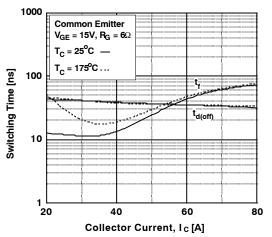


Figure 16. Turn-off Characteristics vs. Collector Current

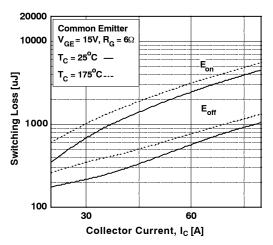


Figure 18. Switching Loss vs Collector Current

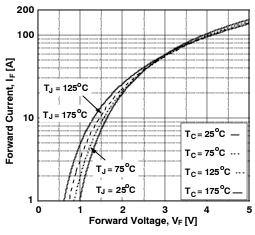


Figure 19. Forward Characteristics

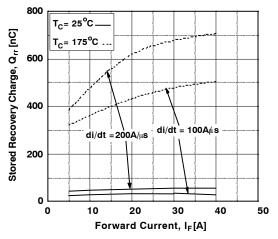


Figure 21. Stored Charge

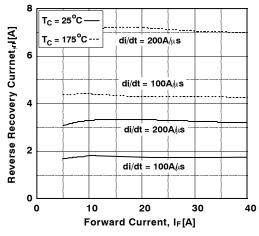


Figure 23. Reverse Recovery Current

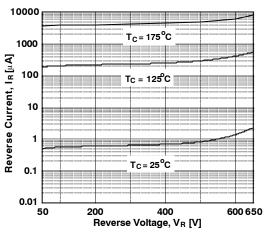


Figure 20. Reverse Current

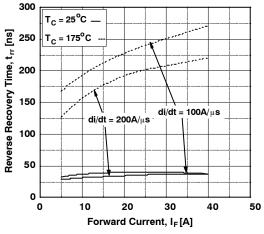


Figure 22. Reverse Recovery Time

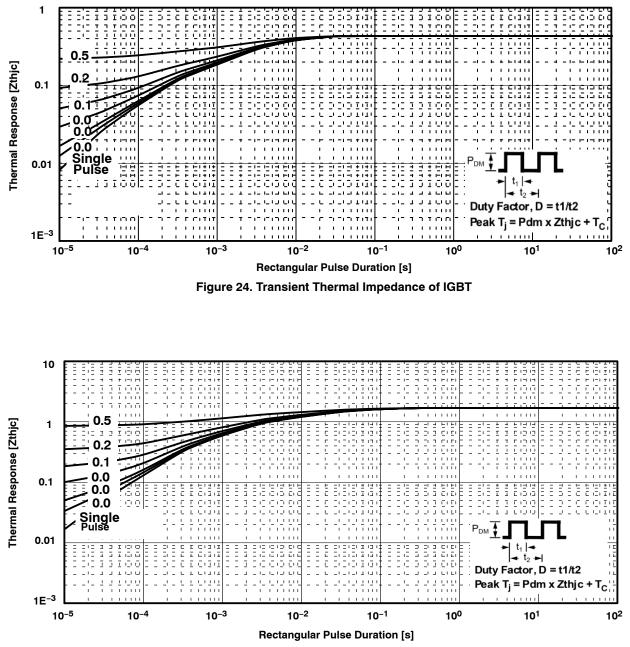
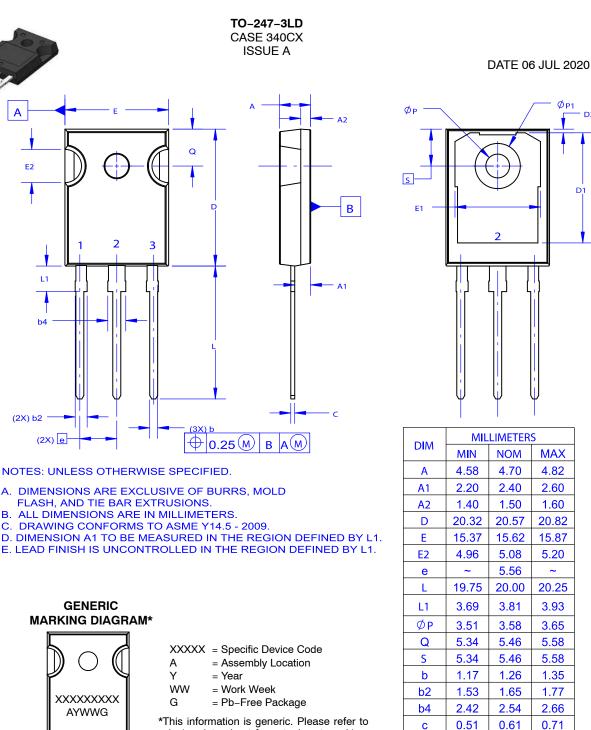


Figure 25. Transient Thermal Impedance of Diode



*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ", may or may not be present. Some products may not follow the Generic Marking.

С

D1

D2

E1

Ø P1

13.08

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12.81

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